

512K x 8 (4-MBIT) DYNAMIC RAM WITH EDO PAGE MODE

PRELIMINARY INFORMATION SEPTEMBER 2001

FEATURES

- · TTL compatible inputs and outputs
- Refresh Interval: 1024 cycles/16 ms
- Refresh Mode: RAS-Only, CAS-before-RAS (CBR), and Hidden
- · JEDEC standard pinout
- · Single power supply

 $5V \pm 10\%$ (IS41C85120)

 $3.3V \pm 10\%$ (IS41LV85120)

Industrail Temperature Range -40°C to 85°C

KEY TIMING PARAMETERS

Parameter	-35	-60	Unit
Max. RAS Access Time (trac)	35	60	ns
Max. CAS Access Time (tcac)	10	15	ns
Max. Column Address Access Time (taa)	18	30	ns
Min. Fast Page Mode Cycle Time (tpc)	12	25	ns
Min. Read/Write Cycle Time (tRC)	60	110	ns

PIN DESCRIPTIONS

A0-A9	Address Inputs
I/O0-I/O7	Data Inputs/Outputs
WE	Write Enable
ŌĒ	Output Enable
RAS	Row Address Strobe
CAS	Column Address Strobe
Vcc	Power
GND	Ground
NC	No Connection

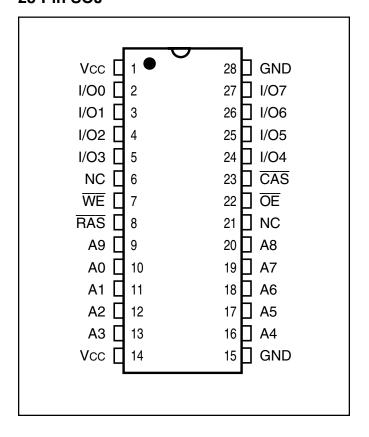
DESCRIPTION

The *ISSI* IS41C85120 and IS41LV85120 are 524,288 x 8-bit high-performance CMOS Dynamic Random Access Memory. Both products offer accelerated cycle access EDO Page Mode. EDO Page Mode allows 512 random accesses within a single row with access cycle time as short as 10ns per 8-bit word. The Byte Write control, of upper and lower byte, makes the IS41C85120 and IS41LV85120 ideal for use in 16 and 32-bit wide data bus systems.

These features make the IS41C85120 and IS41LV85120 ideally suited for high band-width graphics, digital signal processing, high-performance computing systems, and peripheral applications.

The IS41C85120 and IS41LV85120 are available in a 28-pin, 400-mil SOJ package.

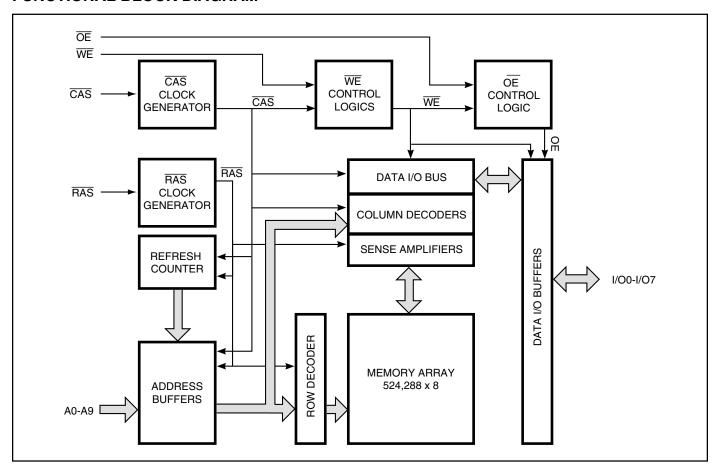
PIN CONFIGURATION 28-Pin SOJ



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FUNCTIONAL BLOCK DIAGRAM





TRUTH TABLE

Function	RAS	CAS	WE	ŌĒ	Address tr/tc	I/O
Standby	Н	Н	Х	Х	Х	High-Z
Read: Word	L	L	Н	L	ROW/COL	Douт
Read: Lower Byte	L	L	Н	L	ROW/COL	Lower Byte, Dout Upper Byte, High-Z
Read: Upper Byte	L	Н	Н	L	ROW/COL	Lower Byte, High-Z Upper Byte, Dout
Write: Word (Early Write)	L	L	L	Х	ROW/COL	Din
Write: Lower Byte (Early Write)	L	L	L	Х	ROW/COL	Lower Byte, DIN Upper Byte, High-Z
Write: Upper Byte (Early Write)	L	Н	L	Х	ROW/COL	Lower Byte, High-Z Upper Byte, DIN
Read-Write ^(1,2)	L	L	H→L	L→H	ROW/COL	Dout, Din
EDO Page-Mode Read ⁽²⁾	1st Cycle:	L	H→L	Н	L	ROW/COL
	2nd Cycle:		$H{ ightarrow} L$	Н	L	NA/COL Dout
	Any Cycle:	L	L→H	Н	L	NA/NA Dout
EDO Page-Mode Write(1)	1st Cycle:	L	$H{ ightarrow} L$	L	Χ	ROW/COL DIN
	2nd Cycle:	L	H→L	L	X	NA/COL DIN
EDO Page-Mode Dout, DIN	1st Cycle:	L	H→L	H→L	L→H	ROW/COL
Read-Write ^(1,2)	2nd Cycle:	L	$H{ ightarrow} L$	$H{ ightarrow} L$	$L{ ightarrow}H$	NA/COL DOUT, DIN
Hidden Refresh ²⁾ Douт	Read	L→H→L	L	Н	L	ROW/COL
Dout	Write	$L{\rightarrow}H{\rightarrow}L$	L	L	X	ROW/COL
RAS-Only Refresh	L	Н	Х	Х	ROW/NA	High-Z
CBR Refresh ⁽³⁾	H→L	L	Х	Х	Х	High-Z

These WRITE cycles may also be BYTE WRITE cycles (either LCAS or UCAS active).
 These READ cycles may also be BYTE READ cycles (either LCAS or UCAS active).
 At least one of the two CAS signals must be active (LCAS or UCAS).



Functional Description

The IS41C85120 and IS41LV85120 is a CMOS DRAM optimized for high-speed bandwidth, low power applications. During READ or WRITE cycles, each bit is uniquely addressed through the 19 address bits. The first ten address bits (A0-A9) are entered as row address and latter nine bits nine address bits (A0-A8) are entered as column address. The row address is latched by the Row Address Strobe (\overline{RAS}). The column address is latched by the Column Address Strobe (\overline{CAS}). \overline{RAS} is used to latch the first nine bits and \overline{CAS} is used the latter nine bits.

Memory Cycle

A memory cycle is initiated by bring RAS LOW and it is terminated by returning both RAS and CAS HIGH. To ensures proper device operation and data integrity any memory cycle, once initiated, must not be ended or aborted before the minimum tras time has expired. A new cycle must not be initiated until the minimum precharge time trap, top has elapsed.

Read Cycle

A read cycle is initiated by the falling edge of \overline{CAS} or \overline{OE} , whichever occurs last, while holding \overline{WE} HIGH. The column address must be held for a minimum time specified by tar. Data Out becomes valid only when trac, taa, tcac and toea are all satisfied. As a result, the access time is dependent on the timing relationships between these parameters.

Write Cycle

A write cycle is initiated by the falling edge of \overline{CAS} and \overline{WE} , whichever occurs last. The input data must be valid at or before the falling edge of \overline{CAS} or \overline{WE} , whichever occurs last.

Refresh Cycle

To retain data, 1024 refresh cycles are required in each 16 ms period. There are two ways to refresh the memory.

- By clocking each of the 1024 row addresses (A0 through A9) with RAS at least once every 16 ms. Any read, write, read-modify-write or RAS-only cycle refreshes the addressed row.
- 2. Using a CAS-before-RAS refresh cycle. CAS-before-RAS refresh is activated by the falling edge of RAS, while holding CAS LOW. In CAS-before-RAS refresh cycle, an internal 10-bit counter provides the row addresses and the external address inputs are ignored.

CAS-before-RAS is a refresh-only mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle.

Extended Data Out Page Mode

EDO page mode operation permits all 512 columns within a selected row to be randomly accessed at a high data rate

In EDO page mode read cycle, the data-out is held to the next $\overline{\text{CAS}}$ cycle's falling edge, instead of the rising edge. For this reason, the valid data output time in EDO page mode is extended compared with the fast page mode. In the fast page mode, the valid data output time becomes shorter as the $\overline{\text{CAS}}$ cycle time becomes shorter. Therefore, in EDO page mode, the timing margin in read cycle is larger than that of the fast page mode even if the $\overline{\text{CAS}}$ cycle time becomes shorter.

 $\overline{\text{CAS}}$ cycle time can be shorter than in the fast page mode if the timing margin is the same.

The EDO page mode allows both read and write operations during one \overline{RAS} cycle, but the performance is equivalent to that of the fast page mode in that case.

Power-On

After application of the Vcc supply, an initial pause of 200 μ s is required followed by a minimum of eight initialization cycles (any combination of cycles containing a RAS signal).

During power-on, it is recommended that \overline{RAS} track with Vcc or be held at a valid VIH to avoid current surges.



ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameters		Rating	Unit
V _T	Voltage on Any Pin Relative to GND	5V	-1.0 to +7.0	V
		3.3V	-0.5 to 4.6	V
Vcc	Supply Voltage	5V	-1.0 to +7.0	V
		3.3V	-0.5 to 4.6	V
Іоит	Output Current		50	mA
PD	Power Dissipation		1	W
TA	Commercial Operation Temperature		0 to +70	°C
	Industrail Temperature		-40 to +85	°C
Тѕтс	Storage Temperature		-55 to +125	°C

Note:

RECOMMENDED OPERATING CONDITIONS (Voltages are referenced to GND.)

Symbol	Parameter		Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	5V	4.5	5.0	5.5	٧
		3.3V	3.0	3.3	3.6	
VIH	Input High Voltage	5V	2.4	_	Vcc + 1.0	V
		3.3V	2.0	_	Vcc + 0.3	
VIL	Input Low Voltage	5V	-1.0	_	0.8	V
		3.3V	-0.3	_	8.0	
Та	Commercial Ambient Temperature		0	_	70	°C
	Industrail Ambient Temperature		-40	_	85	°C

CAPACITANCE(1,2)

Symbol	Parameter	Max.	Unit
CIN1	Input Capacitance: A0-A9	5	рF
CIN2	Input Capacitance: RAS, CAS, WE, OE	7	pF
Сю	Data Input/Output Capacitance: I/O0-I/O7	7	pF

Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

 $^{1. \,} Tested \, initially \, and \, after \, any \, design \, or \, process \, changes \, that \, may \, affect \, these \, parameters.$

^{2.} Test conditions: TA = 25°C, f = 1 MHz,



ELECTRICAL CHARACTERISTICS(1)

(Recommended Operation Conditions unless otherwise noted.)

Symbol	Parameter	Test Condition		Speed	Min.	Max.	Unit
lıL	Input Leakage Current	Any input $0V \le V_{IN} \le V_{CC}$ Other inputs not under tes	t = 0V		-10	10	μA
lio	Output Leakage Current	Output is disabled (Hi-Z) $0V \le V_{OUT} \le V_{CC}$			-10	10	μA
Vон	Output High Voltage Level	lон = −2.5 mA			2.4	_	V
Vol	Output Low Voltage Level	IoL = +2.1 mA			_	0.4	V
lcc1	Stand-by Current: TTL	RAS, CAS ≥ VIH	Commercial Industrial Commercial Industrial	5V	_ _ _	3 4 2 3	mA
Icc2	Stand-by Current: CMOS	RAS, CAS ≥ Vcc – 0.2V		5V 3V	_	2 1	mA
Icc3	Operating Current: Random Read/Write ^(2,3,4) Average Power Supply Current	RAS, CAS, Address Cycling, trc = tr	ac (min.)	-35 -60	_	230 170	mA
Icc4	Operating Current: EDO Page Mode ^(2,3,4) Average Power Supply Current	$\overline{RAS} = V_{IL}, \overline{CAS},$ Cycling tpc = tpc (min.)		-35 -60	_	220 160	mA
Icc5	Refresh Current: RAS-Only ^(2,3) Average Power Supply Current	$\overline{\text{RAS}}$ Cycling, $\overline{\text{CAS}} \ge \text{V}_{\text{IH}}$ that $= \text{that}$ (min.)		-35 -60	_	230 170	mA
Icc6	Refresh Current: CBR ^(2,3,5) Average Power Supply Current	RAS, CAS Cycling trc = trc (min.)		-35 -60	_	230 170	mA

^{1.} An initial pause of 200 µs is required after power-up followed by eight \overline{RAS} refresh cycles (\overline{RAS} -Only or CBR) before proper device operation is assured. The eight \overline{RAS} cycles wake-up should be repeated any time the tree refresh requirement is exceeded.

^{2.} Dependent on cycle rates.

^{3.} Specified values are obtained with minimum cycle time and the output open.

^{4.} Column-address is changed once each EDO page cycle.

^{5.} Enables on-chip refresh and address counters.



AC CHARACTERISTICS(1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

		-3	35	-6	0	
Symbol	Parameter	Min.	Max.	Min.	Max.	Units
trc	Random READ or WRITE Cycle Time	60	_	110	_	ns
trac	Access Time from RAS(6, 7)	35	_	60	_	ns
tcac	Access Time from CAS(6, 8, 15)	_	10	_	15	ns
taa	Access Time from Column-Address ⁽⁶⁾	_	18	_	30	ns
tras	RAS Pulse Width	35	10K	60	10K	ns
trp	RAS Precharge Time	20	_	40	_	ns
tcas	CAS Pulse Width ⁽²⁶⁾	6	10K	10	10K	ns
tcp	CAS Precharge Time ^(9, 25)	5	_	10	_	ns
tсsн	CAS Hold Time (21)	35	_	60	_	ns
trcd	RAS to CAS Delay Time(10, 20)	11	28	20	45	ns
tasr	Row-Address Setup Time	0	_	0	_	ns
trah	Row-Address Hold Time	6	_	10	_	ns
tasc	Column-Address Setup Time(20)	0	_	0	_	ns
tcah	Column-Address Hold Time(20)	6	_	10	_	ns
tar	Column-Address Hold Time (referenced to RAS)	30	_	40	_	ns
trad	RAS to Column-Address Delay Time(11)	10	20	15	30	ns
tral	Column-Address to RAS Lead Time	18	_	30	_	ns
trpc	RAS to CAS Precharge Time	0	_	0	_	ns
trsh	RAS Hold Time ⁽²⁷⁾	8	_	115	_	ns
tclz	CAS to Output in Low-Z(15, 29)	3	_	3	_	ns
tcrp	CAS to RAS Precharge Time(21)	5	_	5	_	ns
top	Output Disable Time(19, 28, 29)	3	12	3	12	ns
toe / toea	Output Enable Time(15, 16)	0	10	_	15	ns
toehc	OE HIGH Hold Time from CAS HIGH	10	_	10	_	ns
toep	OE HIGH Pulse Width	10	_	10	_	ns
toes	OE LOW to CAS HIGH Setup Time	5	_	5	_	ns
trcs	Read Command Setup Time(17, 20)	0	_	0	_	ns
trrh	Read Command Hold Time (referenced to RAS) ⁽¹²⁾	0	_	0	_	ns
tпсн	Read Command Hold Time (referenced to CAS)(12, 17, 21)	0	_	0	_	ns
twcн	Write Command Hold Time(17, 27)	5	_	10	_	ns
twcr	Write Command Hold Time (referenced to RAS)(17)	30	_	50	_	ns



AC CHARACTERISTICS (Continued)(1,2,3,4,5,6) (Recommended Operating Conditions unless otherwise noted.)

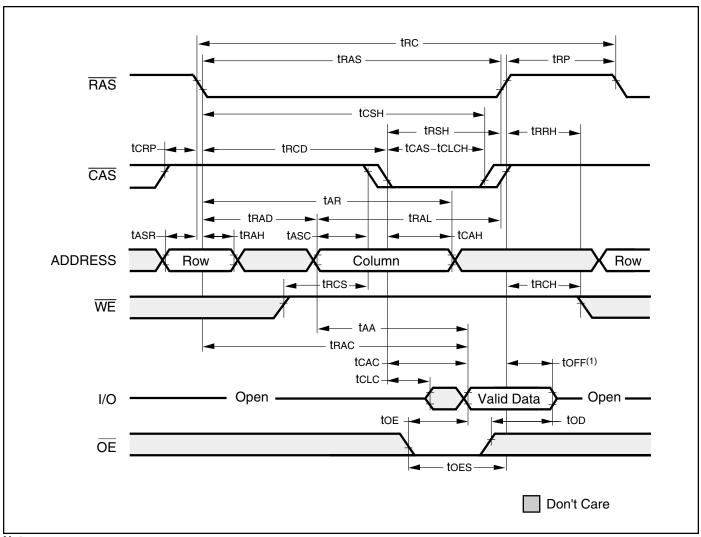
			35	-6	0	
Symbol	Parameter	Min.	Max.	Min.	Max.	Units
twp	Write Command Pulse Width(17)	5	_	10	_	ns
twpz	WE Pulse Widths to Disable Outputs	10	_	10	_	ns
trwL	Write Command to RAS Lead Time(17)	8	_	15	_	ns
tcwL	Write Command to CAS Lead Time(17, 21)	8	_	15	_	ns
twcs	Write Command Setup Time(14, 17, 20)	0	_	0	_	ns
tdhr	Data-in Hold Time (referenced to $\overline{\text{RAS}}$) Precharge during WRITE Cycle	30	_	40	_	ns
tоен	OE Hold Time from WE during READ-MODIFY-WRITE cycle ⁽¹⁸⁾	8	_	15	_	ns
tos	Data-In Setup Time(15, 22)	0	_	0	_	ns
tон	Data-In Hold Time(15, 22)	6	_	10	_	ns
trwc	READ-MODIFY-WRITE Cycle Time	80	_	140	_	ns
trwd	RAS to WE Delay Time during READ-MODIFY-WRITE Cycle ⁽¹⁴⁾	45	_	80	_	ns
tcwp	CAS to WE Delay Time(14, 20)	25	_	36	_	ns
tawd	Column-Address to WE Delay Time(14)	30	_	49	_	ns
tPC	EDO Page Mode READ or WRITE Cycle Time ⁽²⁴⁾	12	_	25	_	ns
trasp	RAS Pulse Width in EDO Page Mode	35	100K	60	100K	ns
tcpa	Access Time from CAS Precharge(15)	_	21	_	34	ns
tPRWC	EDO Page Mode READ-WRITE Cycle Time ⁽²⁴⁾	40	_	56	_	ns
tсон/tрон	Data Output Hold after CAS LOW	5	_	5	_	ns
toff	Output Buffer Turn-Off Delay from CAS or RAS(13,15,19, 29)	3	15	3	15	ns
twnz	Output Disable Delay from WE	3	15	3	15	ns
tclch	Last CAS going LOW to First CAS returning HIGH ⁽²³⁾	10	_	10	_	ns
tcsr	CAS Setup Time (CBR REFRESH)(30, 20)	8	_	10	_	ns
tchr	CAS Hold Time (CBR REFRESH)(30, 21)	8	_	10	_	ns
tord	OE Setup Time prior to RAS during HIDDEN REFRESH Cycle	0	_	0	_	ns
tref	Refresh Period (1024 Cycles)	_	16	_	16	ms
tτ	Transition Time (Rise or Fall)(2, 3)	1	50	1	50	ns



- 1. An initial pause of 200 µs is required after power-up followed by eight \overline{RAS} refresh cycle (\overline{RAS} -Only or CBR) before proper device operation is assured. The eight \overline{RAS} cycles wake-up should be repeated any time the tree refresh requirement is exceeded.
- 2. VIH (MIN) and VIL (MAX) are reference levels for measuring timing of input signals. Transition times, are measured between VIH and VIL (or between VIL and VIH) and assume to be 1 ns for all inputs.
- 3. In addition to meeting the transition rate specification, all input signals must transit between V_{IH} and V_{IL} (or between V_{IL} and V_{IH}) in a monotonic manner.
- 4. If \overline{CAS} and $\overline{RAS} = V_{IH}$, data output is High-Z.
- 5. If $\overline{CAS} = V_{IL}$, data output may contain data from the last valid READ cycle.
- 6. Measured with a load equivalent to one TTL gate and 50 pF.
- 7. Assumes that tRCD tRCD (MAX). If tRCD is greater than the maximum recommended value shown in this table, tRAC will increase by the amount that tRCD exceeds the value shown.
- 8. Assumes that trco trco (MAX).
- 9. If $\overline{\text{CAS}}$ is LOW at the falling edge of $\overline{\text{RAS}}$, data out will be maintained from the previous cycle. To initiate a new cycle and clear the data output buffer, $\overline{\text{CAS}}$ and $\overline{\text{RAS}}$ must be pulsed for tcp.
- 10. Operation with the trop (MAX) limit ensures that trac (MAX) can be met. trop (MAX) is specified as a reference point only; if trop is greater than the specified trop (MAX) limit, access time is controlled exclusively by trac.
- 11. Operation within the trad (MAX) limit ensures that trad (MAX) can be met. trad (MAX) is specified as a reference point only; if trad is greater than the specified trad (MAX) limit, access time is controlled exclusively by trad.
- 12. Either trich or trich must be satisfied for a READ cycle.
- 13. toff (MAX) defines the time at which the output achieves the open circuit condition; it is not a reference to Voh or Vol.
- 14. twcs, trwo, tawo and tcwo are restrictive operating parameters in LATE WRITE and READ-MODIFY-WRITE cycle only. If twcs twcs (MIN), the cycle is an EARLY WRITE cycle and the data output will remain open circuit throughout the entire cycle. If trwo trwo (MIN), tawo trwo (MIN) and tcwo tcwo (MIN), the cycle is a READ-WRITE cycle and the data output will contain data read from the selected cell. If neither of the above conditions is met, the state of I/O (at access time and until CAS and RAS or OE go back to Vih) is indeterminate. OE held HIGH and WE taken LOW after CAS goes LOW result in a LATE WRITE (OE-controlled) cycle.
- 15. Output parameter (I/O) is referenced to corresponding CAS input, I/O0-I/O7 by LCAS and I/O8-I/O15 by UCAS.
- 16. During a READ cycle, if \overline{OE} is LOW then taken HIGH before \overline{CAS} goes HIGH, I/O goes open. If \overline{OE} is tied permanently LOW, a LATE WRITE or READ-MODIFY-WRITE is not possible.
- 17. Write command is defined as \overline{WE} going low.
- 18. LATE WRITE and READ-MODIFY-WRITE cycles must have both top and toeh met (OE HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. The I/Os will provide the previously written data if CAS remains LOW and OE is taken back to LOW after toeh is met.
- 19. The I/Os are in open during READ cycles once top or toff occur.
- 20. The first $\chi \overline{CAS}$ edge to transition LOW.
- 21. The last $\chi \overline{CAS}$ edge to transition HIGH.
- 22. These parameters are referenced to $\overline{\text{CAS}}$ leading edge in EARLY WRITE cycles and $\overline{\text{WE}}$ leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
- 23. Last falling $\chi \overline{CAS}$ edge to first rising $\chi \overline{CAS}$ edge.
- 24. Last rising $\chi \overline{CAS}$ edge to next cycle's last rising $\chi \overline{CAS}$ edge.
- 25. Last rising $\chi \overline{CAS}$ edge to first falling $\chi \overline{CAS}$ edge.
- 26. Each $\chi \overline{CAS}$ must meet minimum pulse width.
- 27. Last $\chi \overline{CAS}$ to go LOW.
- 28. I/Os controlled, regardless \overline{UCAS} and \overline{LCAS} .
- 29. The 3 ns minimum is a parameter guaranteed by design.
- 30. Enables on-chip refresh and address counters.



AC WAVEFORMS READ CYCLE

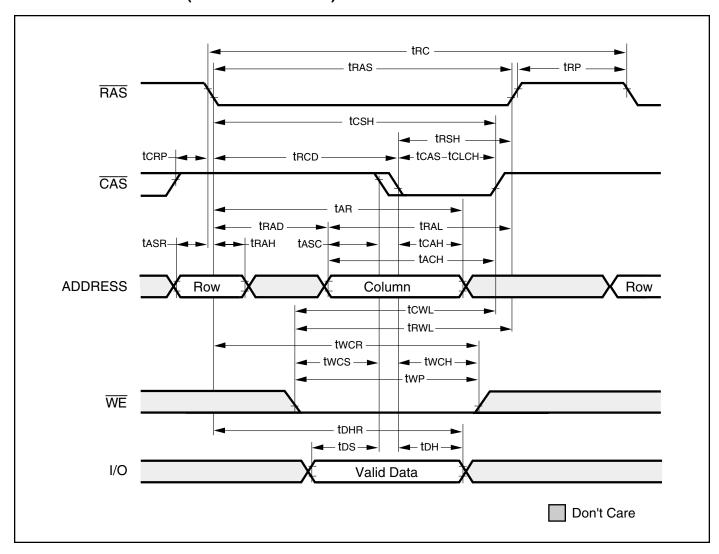


Note:

1. toff is referenced from rising edge of \overline{RAS} or \overline{CAS} , whichever occurs last.

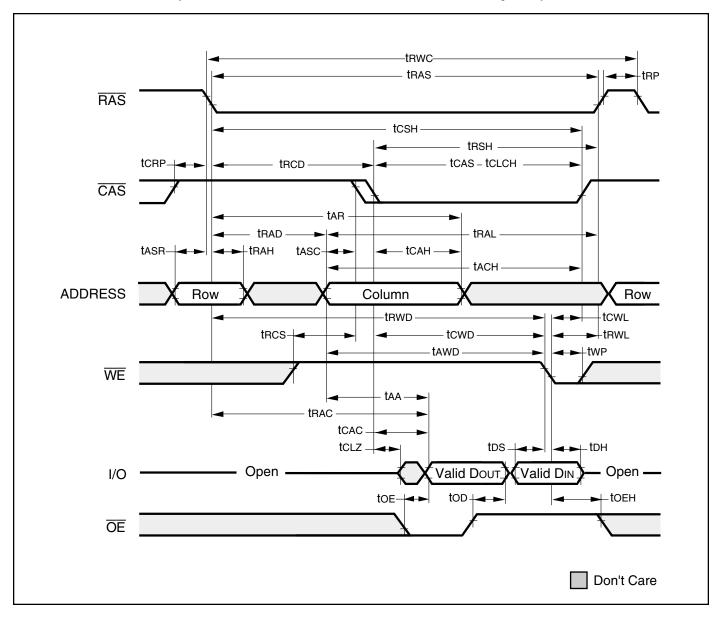


EARLY WRITE CYCLE (OE = DON'T CARE)



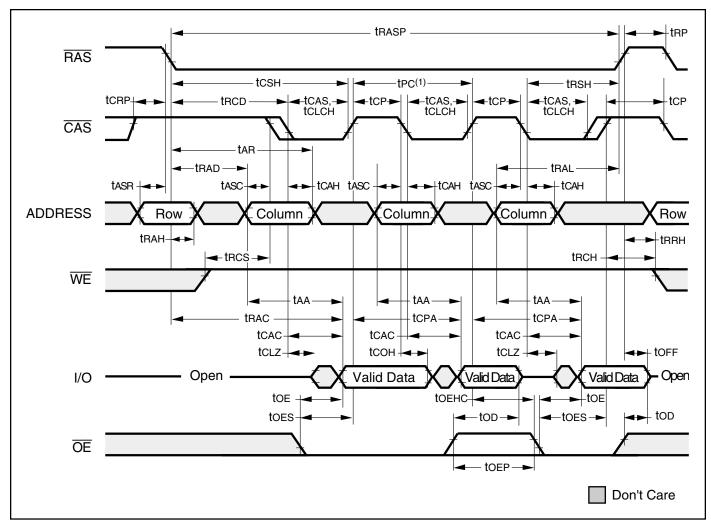


READ WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE Cycles)





EDO-PAGE-MODE READ CYCLE

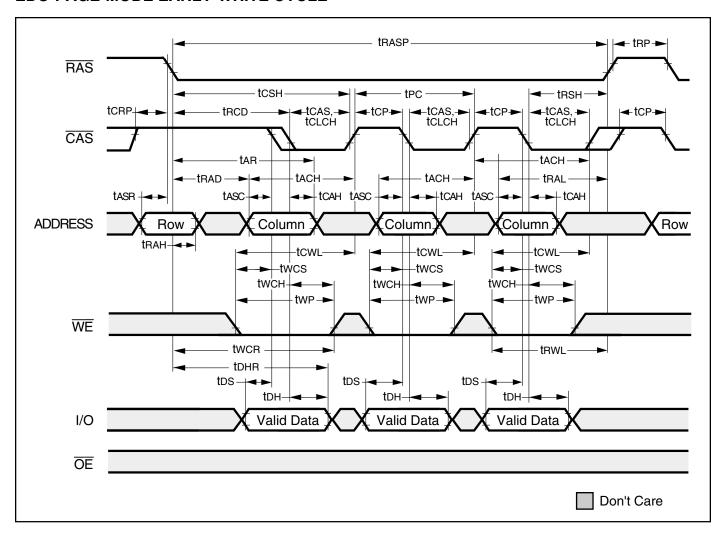


Note:

1. tPC can be measured from falling edge of \overline{CAS} to falling edge of \overline{CAS} , or from rising edge of \overline{CAS} to rising edge of \overline{CAS} . Both measurements must meet the tPC specifications.

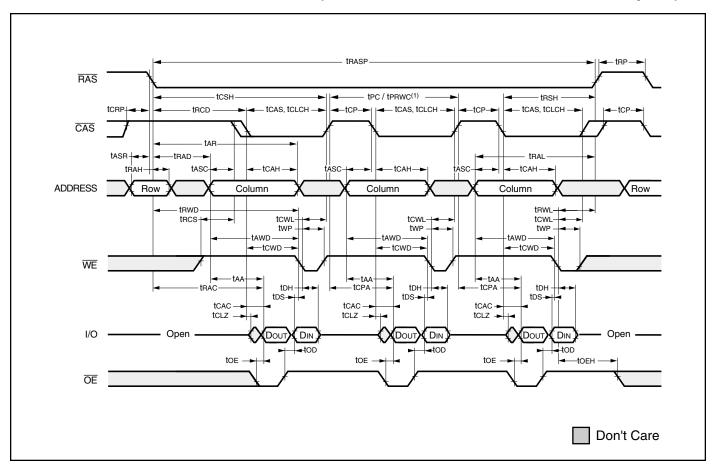


EDO-PAGE-MODE EARLY-WRITE CYCLE





EDO-PAGE-MODE READ-WRITE CYCLE (LATE WRITE and READ-MODIFY WRITE Cycles)

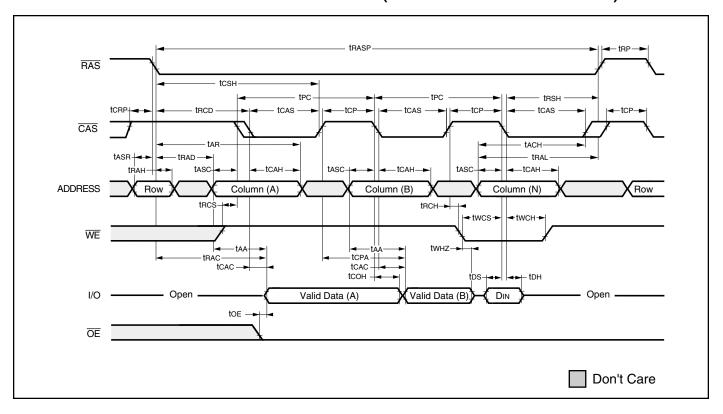


Note:

1. tPC can be measured from falling edge of \overline{CAS} to falling edge of \overline{CAS} , or from rising edge of \overline{CAS} to rising edge of \overline{CAS} . Both measurements must meet the tPC specifications.

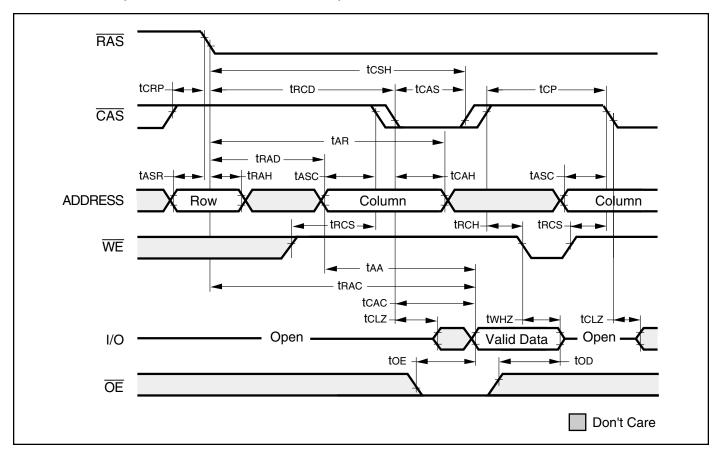


EDO-PAGE-MODE READ-EARLY-WRITE CYCLE (Psuedo READ-MODIFY WRITE)

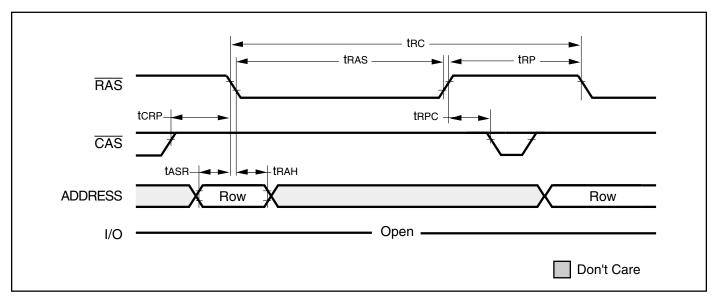




READ CYCLE (With WE-Controlled Disable)

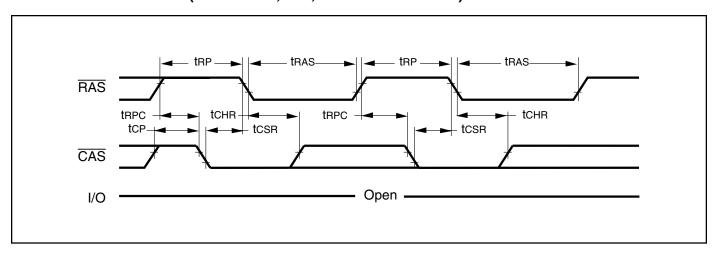


RAS-ONLY REFRESH CYCLE (OE, WE = DON'T CARE)

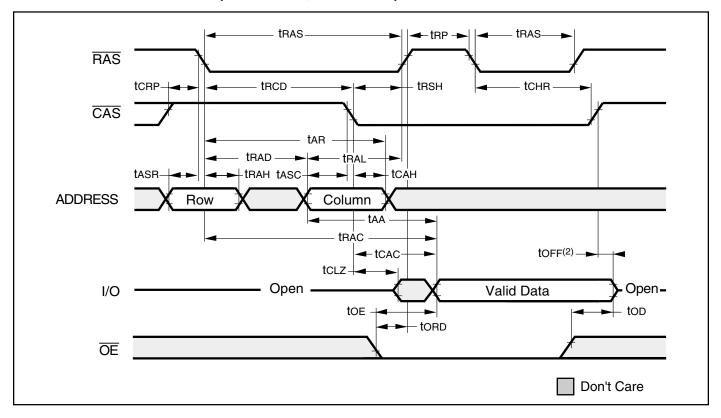




CBR REFRESH CYCLE (Addresses; WE, OE = DON'T CARE)



HIDDEN REFRESH CYCLE (WE = HIGH; OE = LOW)(1)



- 1. A Hidden Refresh may also be perfor<u>med</u> afte<u>r a Write Cycle</u>. In this case, $\overline{\text{WE}} = \text{LOW}$ and $\overline{\text{OE}} = \text{HIGH}$.
- 2. toff is referenced from rising edge of RAS or CAS, whichever occurs last.



ORDERING INFORMATION: 5V Commercial Range: 0.C to 70.C

Speed (ns)	Order Part No.	Package
35	IS41C85120-35K	400-mil SOJ
60	IS41C85120-60K	400-mil SOJ

ORDERING INFORMATION: 3.3V Commercial Range: 0.C to 70.C

Speed (ns)	Order Part No.	Package
35	IS41LV85120-35K	400-mil SOJ
60	IS41LV85120-60K	400-mil SOJ

ORDERING INFORMATION: 5V Industrail Range: -40·C to 85·C

Speed (ns)	Order Part No.	Package
60	IS41C85120-60KI	400-mil SOJ

ORDERING INFORMATION: 3.3V Industrail Range: -40·C to 85·C

Speed (ns)	Order Part No.	Package
60	IS41LV85120-60KI	400-mil SOJ



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